

M2GL060TS-1FGG676

M2GL060TS-1FGG676 Information



For Reference Only

Part NumberM2GL060TS-1FGG676ManufacturerMicrosemi CorporationCategoryIntegrated Circuits (ICs)

Embedded - FPGAs (Field Programmable Gate

Array)

Description IC FPGA 387 I/O 676FBGA

Package 676-BGA

For the pricing/inventory/lead time, please contact

us

Website: https://www.heisener.com E-mail: salesdept@heisener.com



Request a Quote

Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.









M2GL060TS-1FGG676 Specifications

Manufacturer Part Number	M2GL060TS-1FGG676	
Manufacturer	Microsemi Corporation	
Category	Integrated Circuits (ICs)	
	Embedded - FPGAs (Field Programmable Gate Array)	
Package	676-BGA	
Series	IGLOO2	
Number of LABs/CLBs	-	
Number of Logic Elements/Cells	56520	
Total RAM Bits	1869824	
Number of I/O	387	
Number of Gates	-	
Voltage - Supply	1.14 V ~ 2.625 V	
Mounting Type	Surface Mount	
Operating Temperature	0°C ~ 85°C (TJ)	
Package / Case	676-BGA	
Supplier Device Package	676-FBGA (27x27)	
		Report errors?

M2GL060TS-1FGG676 Guarantees



Quality Guarantees

We provide 90 days warranty. *

If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



Service Guarantees

We guarantee 100% customer satisfaction.

Our experienced sales team and tech support team back our services to satisfy all our customers.

M2GL060TS-1FGG676 Payment Methods





















M2GL060TS-1FGG676 Shipping Methods













If you have any question about M2GL060TS-1FGG676, please do not hesitate to contact us!

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